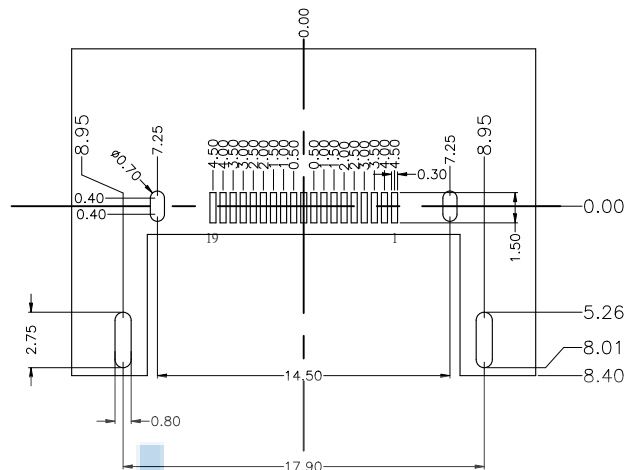


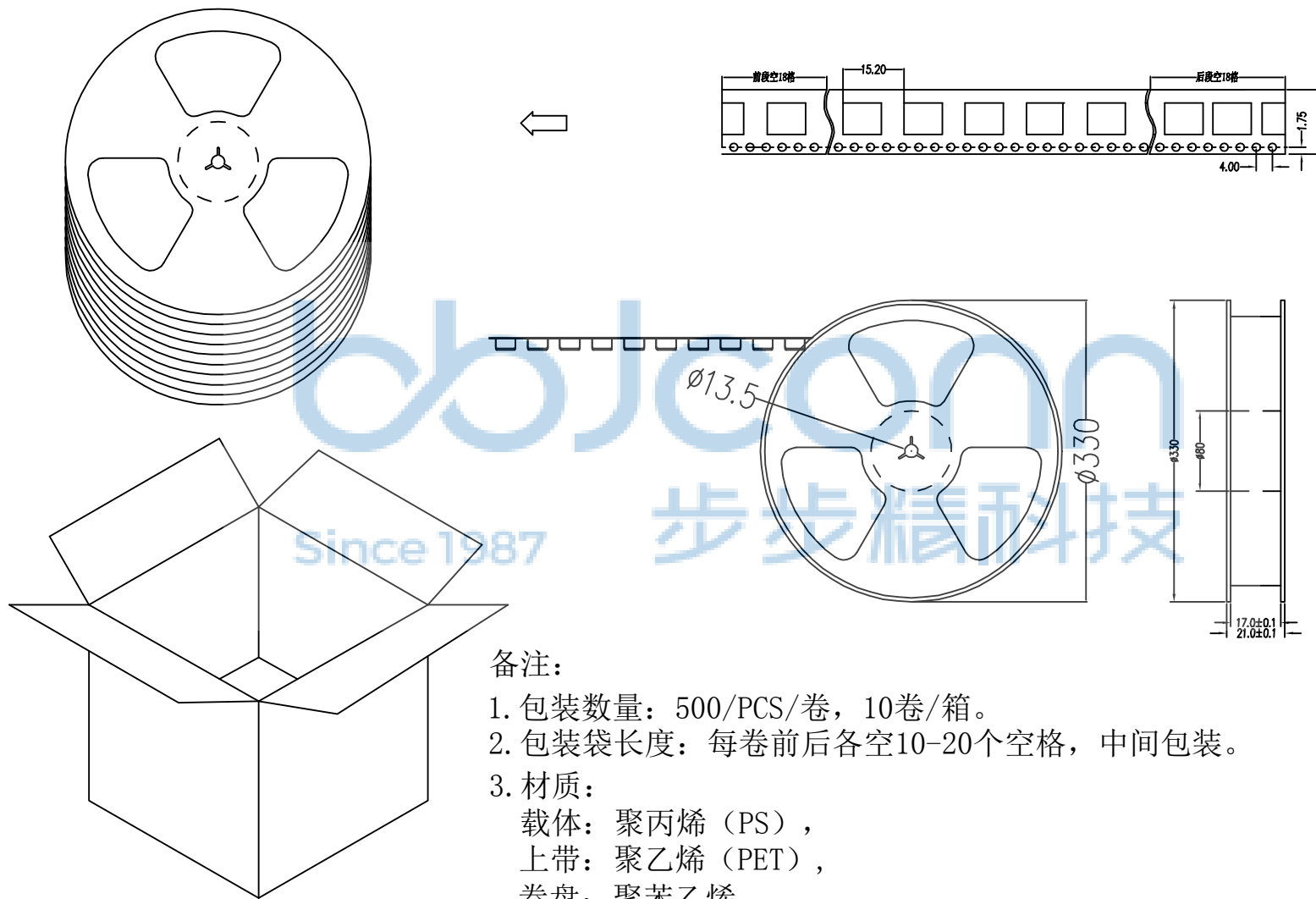
3. material:
HOUSING:THERMOPLASTICS HIGH TEMP LCP+GLASS
FIBER WHITE COLOR,UL94V-0
CONTACT:Copper Alloy ,T=0.20MM
SHELL:Copper Alloy (SPCC) ,T=0.50MM

4. PLATING:
CONTACT:1~30u"GOLD/TIN PLATING ON CONTACT AREA
100u"MIN,TIN PLATING ON SOLDER TAILS
50u"MIN,NICKEL UNDERPLATING OVER ALL
SHELL:80u" , NICKEL UNDERPLATING OVER ALL

5.  Key control size



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备注:

1. 包装数量: 500/PCS/卷, 10卷/箱。
2. 包装袋长度: 每卷前后各空10-20个空格, 中间包装。
3. 材质:
载体: 聚丙烯 (PS),
上带: 聚乙烯 (PET),
卷盘: 聚苯乙烯。

纸箱规格: 345*345*23MM

纸箱规格: 345*345*35MM

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.X: ±0.38	X': ±3'	NAME: HHDMI 19P A母 L=10.85 沉板1.80 四脚插 端子SMT 平口 LCP黑胶 铁壳	
.XX: ±0.25	.X': ±2'		
.XXX: ±0.13	.XX': ±1'	PJ. NO.: 124-221-190002-H5G	
APPD. JM_Zheng	CHKD. LYX	SIZE: A4 DRW NO.:	
PDWG.NO: 0409-1	DR. TSP	FINISH: SEE NOTES MAT'L.: SEE NOTES	
		SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/2	